

**AMENDMENTS TO THE SPECIFICATION**

Paragraph [0025] of the electronically filed specification is amended to read as follows:

Thus, any problem of gas evolution from porogens may be addressed by the configuration of the surrounding interconnect structure itself. For example, the structure may be formed either with dedicated openings to allow the gas to relieve itself outward, such as through pipes to the outer surface of the device. Alternatively, the structure may be built to contain the pressure (and ~~possible~~ possibly even effectively become a near 100% air gap like structure, given sufficient dielectric degradation). The remaining dielectric material could then form a spider-like web of material that holds the interconnects in place, but maintains sufficient separation for operation and attains increased performance.